

60V N-Channel Mosfet

FEATURES

- $R_{DS(ON)} \leq 3.7m\Omega$ (3.2m Ω Typ.)
@ $V_{GS}=10V$
- AEC Q101 qualified
- Green Product (RoHS compliant)

TO-252

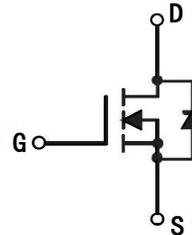


- 1. Gate
- 2. Drain
- 3. Source

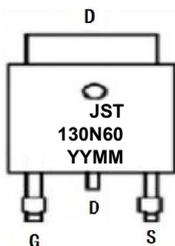
APPLICATIONS

- Automotive electronic pump
- Consumer electronic power supply
- Motor control
- Synchronous-rectification

N-CHANNEL MOSFET



MARKING



YYMM:Date Code(year & month)

MAXIMUM RATINGS ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Limit	Units	
V_{DSS}	Drain-Source Voltage	60	V	
V_{GSS}	Gate-Source Voltage	± 20	V	
I_D	Continuous Drain Current @ $V_{GS}=10V$ <small>note1</small>	$T_C = 25^\circ C$	95	A
		$T_C = 100^\circ C$	67	A
I_{DM}	Pulsed Drain Current <small>note2</small>	315	A	
E_{AS}	Single Pulsed Avalanche Energy <small>note3</small>	300	mJ	
P_D	Power Dissipation <small>note4</small>	60	W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.5	$^\circ C/W$	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <small>note5</small>	120	$^\circ C/W$	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ C$	

MOSFET ELECTRICAL CHARACTERISTICS $T_C=25\text{ }^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$ $T_J = 25^\circ C$	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.2	2.8	3.8	V
$R_{DS(ON)}$	Gate Drain-Source On-State Resistance <small>note6</small>	$V_{GS}=10V, I_D=20A$	-	3.2	3.7	m Ω
Dynamic Characteristics <small>note7</small>						
C_{iss}	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0MHz$	-	4894	-	pF
C_{oss}	Output Capacitance		-	2208	-	pF
C_{rss}	Reverse Transfer Capacitance		-	171	-	pF
Q_g	Total Gate Charge	$V_{DS}=30V, I_D=25A,$ $V_{GS}=10V$	-	87.2	-	nC
Q_{gs}	Gate-Source Charge		-	18.3	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	10.9	-	nC
Switching Characteristics <small>note7</small>						
$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10V, V_{DS}=30V,$ $R_G = 2\Omega, I_D=25A$	-	22.5	-	ns
t_r	Turn-On Rise Time		-	33	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	80.3	-	ns
t_f	Turn-Off Fall Time		-	26.8	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{SD}=20A,$ $T_J = 25^\circ C$	-	-	1.3	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_S = 25A,$	-	70	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt = 100A/\mu s$	-	73	-	nC

- Notes: 1. Calculated continuous current based on maximum allowable junction temperature.
2. Repetitive rating; pulse width limited by max. junction temperature.
3. $V_{DD}=30\text{ V}$, $R_G=25\text{ }\Omega$, $L=0.5\text{ mH}$, starting $T_j=25\text{ }^\circ\text{C}$.
4. P_d is based on max. junction temperature, using junction-case thermal resistance.
5. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_j=25\text{ }^\circ\text{C}$.
6. Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 1\%$
7. Guaranteed by design, not subject to production testing

Typical Performance Characteristics

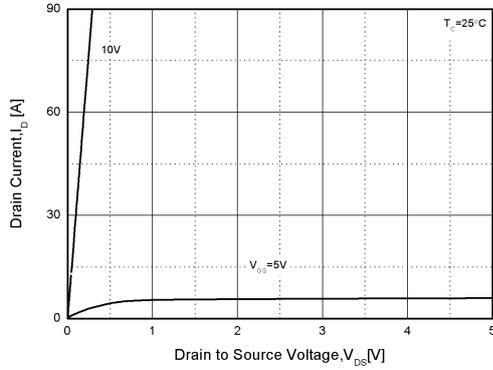


Figure1. Output Characteristics

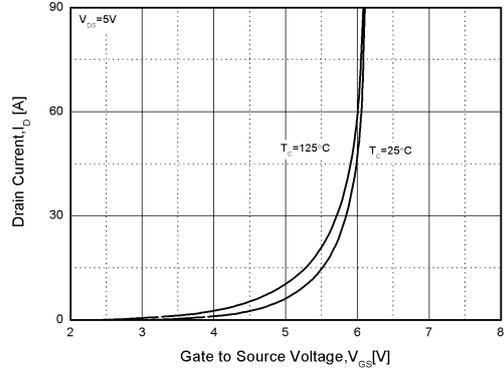


Figure2. Transfer Characteristics

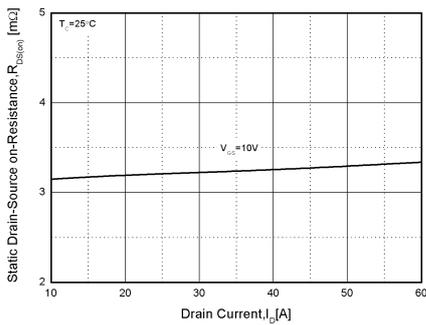


Figure3. Rdson-Drain Current

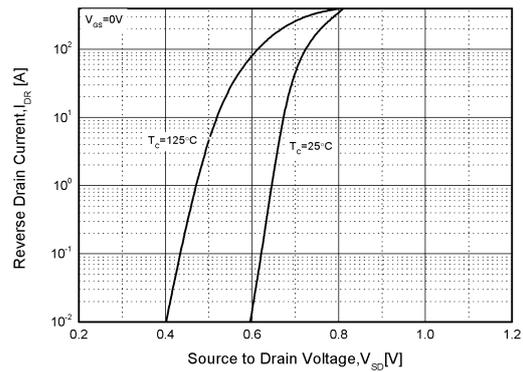


Figure4. Typical Source-Drain Diode Forward Voltage

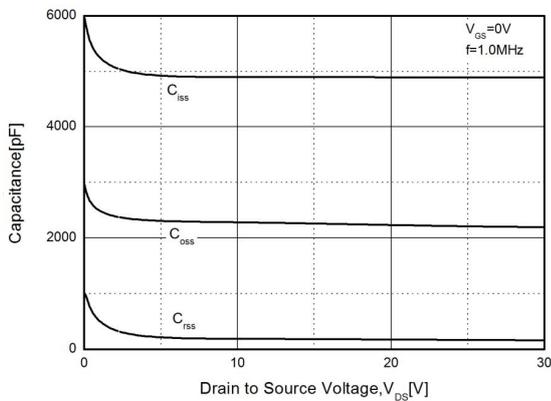


Figure5. Capacitance Characteristics

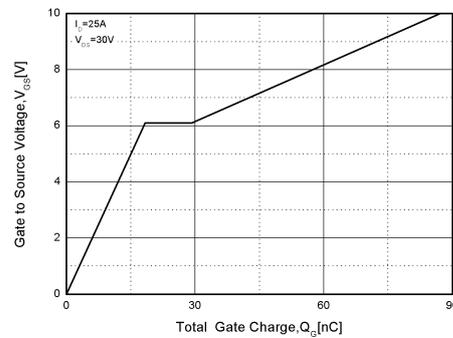


Figure6. Gate Charge

Typical Performance Characteristics (cont.)

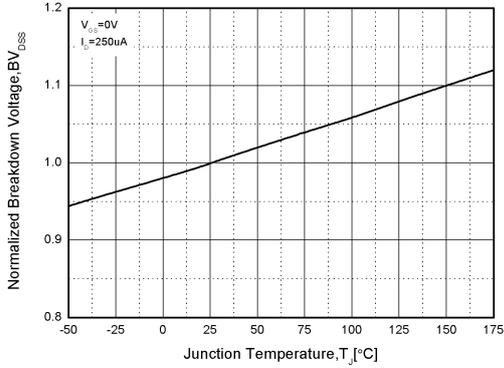


Figure7. Normalized Breakdown Voltage vs. Temperature

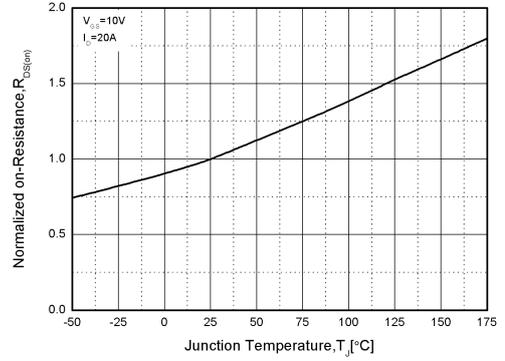


Figure8. Normalized on-Resistance vs. Temperature

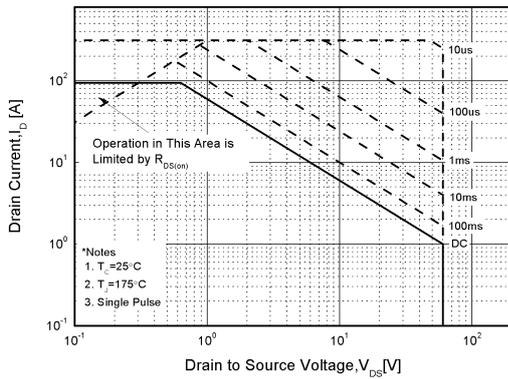


Figure9. Safe Operation Area

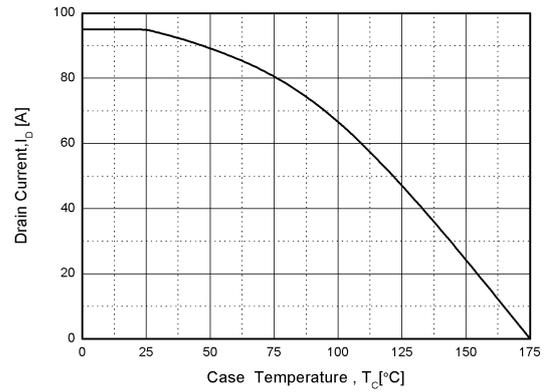


Figure10. Drain Current vs. Case Temperature

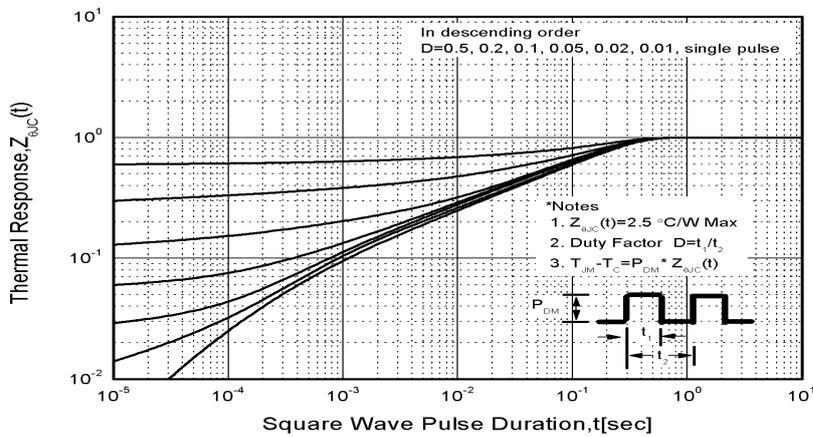
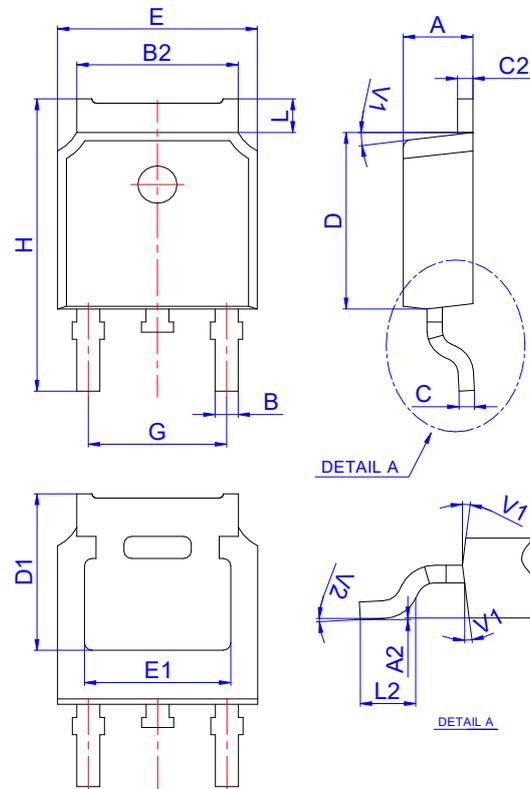


Figure11. Transient Thermal Response Curve

TO-252 PACKAGE OUTLINE DRAWING



Symbols	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°